

TABLE 1. ELECTRICAL TESTS:

TEST	Symbol	CONDITIONS -55 °C <=T _A <= +125°C V ⁺ =+15V, V ⁻ =-15V, GND=0V V _{INH} =2.4V, V _{INL} =0.8V, V _L =5V Unless otherwise specified		Group A Subgroup	Device type	Limits Min ⏟/	Limits Max ⏟/	Units
SWITCH								
Analog-Signal Range	V _{ANALOG}	3/		1,2,3	All	-15	15	V
Drain-Source ON Resistance	r _{DS(ON)}	V ⁺ =+13.5V V ⁻ =-13.5V I _S =-10mA V _D =±12.5V	V _{IN} =0.8V	1 2,3	01	2.5 2.5	35 45	Ω
			V _{IN} =2.4V	1 2,3	02	2.5 2.5	35 45	
			V _{IN} =0.8V, 2.4V 4/	1 2,3	03	2.5 2.5	35 45	
Source-OFF Leakage Current	I _{S(OFF)}	V ⁺ =+16.5V V ⁻ =-16.5V V _D =±15.5V V _S =±15.5V	V _{IN} =2.4V	1 2,3	01	-0.25 -20	0.25 20	nA
			V _{IN} =0.8V	1 2,3	02	-0.25 -20	0.25 20	
			V _{IN} =0.8V, 2.4V 4/	1 2,3	03	-0.25 -20	0.25 20	
Drain-OFF Leakage Current	I _{D(OFF)}	V ⁺ =+16.5V, V ⁻ =-16.5V, V _D =±15.5V, V _S =±15.5V	V _{IN} =2.4V	1 2,3	01	-0.25 -20	0.25 20	nA
			V _{IN} =0.8V	1 2,3	02	-0.25 -20	0.25 20	
			V _{IN} =0.8V, 2.4V 4/	1 2,3	03	-0.75 -60	0.75 60	
Drain-ON Leakage Current	I _{D(ON)}	V ⁺ =+16.5V, V ⁻ =-16.5V, V _D =±15.5V, V _S =±15.5V	V _{IN} =0.8V	1 2,3	01	-0.4 -40	0.4 40	nA
			V _{IN} =2.4V	1 2,3	02	-0.4 -40	0.4 40	
			V _{IN} =0.8V, 2.4V 4/	1 2,3	03	-0.75 -60	0.75 60	
Input Current/Voltage High	I _{INH}	V _{IN} = 2.4V		1,2,3	All	-0.5	0.5	μA
Input Current/Voltage Low	I _{INL}	V _{IN} = 0.8V		1,2,3	All	-0.5	0.5	μA
Positive Supply Current	I+	V ⁺ =+16.5V, V ⁻ =-16.5V, V _{IN} =0V or 5V		1 2,3	All	-1.0 -5.0	1.0 5.0	μA
Negative Supply Current	I-	V ⁺ =+16.5V, V ⁻ =-16.5V, V _{IN} =0V or 5V		1 2,3	All	-1.0 -5.0	1.0 5.0	μA

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Logic Supply Current	I _L	V ⁺ =+16.5V, V ⁻ =-16.5V, V _{IN} =0V or 5V	1 2,3	All	-1.0 -5.0	1.0 5.0	μA
Ground Current	I _{GND}	V ⁺ =+16.5V, V ⁻ =-16.5V, V _{IN} =0V or 5V	1 2,3	All	-1.0 -5.0	1.0 5.0	μA
Turn-Off Time	t _{OFF}	V _D =±10V, R _L =300Ω, CL=35pF, Figure 2	9 10,11	01,02		145 210	ns
Transition Time	t _{TRANS}	V _S =±10V, R _L =300Ω, CL=35pF, Figure 3	9 10,11	03		175 250	ns
Break-Before-Make Interval	t _D	V _{S1} =V _{S2} =±10V, R _L =300Ω, CL=35pF, Figure 4	9	03	5	150	ns
Charge Injection 3/	Q	V _{GEN} =0V, Figure 5	9	All		10	pC
Functional Tests	FT	Verify Truth Table	7,8	All			

NOTE 2: This data sheet uses the algebraic convention, where the most negative value is a minimum and the most positive value is a maximum.

NOTE 3: Guaranteed by design.

NOTE 4: V_{IN}=input voltage to perform proper function.

FIGURE 2: SWITCHING TIME TEST CIRCUIT for DG417/DG418: See Commercial Data Sheet

FIGURE 3: TRANSITION TIME for DG419: See Commercial Data Sheet

FIGURE 4: BREAK-BEFORE-MAKE INTERVAL for DG419: See Commercial Data Sheet

FIGURE 5: CHARGE INJECTION for DG417/DG418/DG419: See Commercial Data Sheet

TRUTH TABLES:

DG417	DG417	DG418	DG418	DG419	DG419	DG419
LOGIC	SWITCH	LOGIC	SWITCH	LOGIC	SWITCH 1	SWITCH 2
0	ON	0	OFF	0	ON	OFF
1	OFF	1	ON	1	OFF	ON

ORDERING INFORMATION:

Package	MAXIM PART	SMD NUMBER
8 pin Cerdip	DG417AK/883B	5962-9073701MPA
10 pin Flatpack	DG417AL/883B	5962-9073701MXC
8 pin Cerdip	DG418AK/883B	5962-9073702MPA
10 pin Flatpack	DG418AL/883B	5962-9073702MXC
8 pin Cerdip	DG419AK/883B	5962-9073703MPA
10 pin Flatpack	DG419AL/883B	5962-9073703MXC

TERMINAL CONNECTIONS:

	DG417/418	DG417/418	DG419	DG419
	J8	F10	J8	F10
1	S	S	D	D
2	NC	NC	S1	S1
3	GND	GND	GND	GND
4	V+	V+	V+	V+
5	V _L	NC	V _L	NC
6	IN	NC	IN	NC
7	V-	V _L	V-	V _L
8	D	IN	S2	IN
9		V-		V-
10		D		S2

QUALITY ASSURANCE

Sampling and inspection procedures shall be in accordance with MIL-Prf-38535, Appendix A as specified in Mil-Std-883.

Screening shall be in accordance with Method 5004 of Mil-Std-883. Burn-in test Method 1015:

1. Test Condition, A, B, C, or D.
2. TA = +125°C minimum.
3. Interim and final electrical test requirements shall be specified in Table 2.

Quality conformance inspection shall be in accordance with Method 5005 of Mil-Std-883, including Groups A, B, C, and D inspection.

Group A inspection:

1. Tests as specified in Table 2.
2. Selected subgroups in Table 1, Method 5005 of Mil-Std-883 shall be omitted.

Group C and D inspections:

- a. End-point electrical parameters shall be specified in Table 1.
- b. Steady-state life test, Method 1005 of Mil-Std-883:
 1. Test condition A, B, C, D.
 2. TA = +125°C, minimum.
 3. Test duration, 1000 hours, except as permitted by Method 1005 of Mil-Std-883.

TABLE 2. ELECTRICAL TEST REQUIREMENTS

Mil-Std-883 Test Requirements	Subgroups per Method 5005, Table 1
Interim Electric Parameters Method 5004	1
Final Electrical Parameters Method 5005	1*, 2, 3, 9, 10, 11
Group A Test Requirements Method 5005	1, 2, 3, 7**, 8**, 9, 10, 11
Group C and D End-Point Electrical Parameters Method 5005	1

* PDA applies to Subgroup 1 only.

** Subgroups 7 and 8 tests shall be sufficient to verify the truth table.